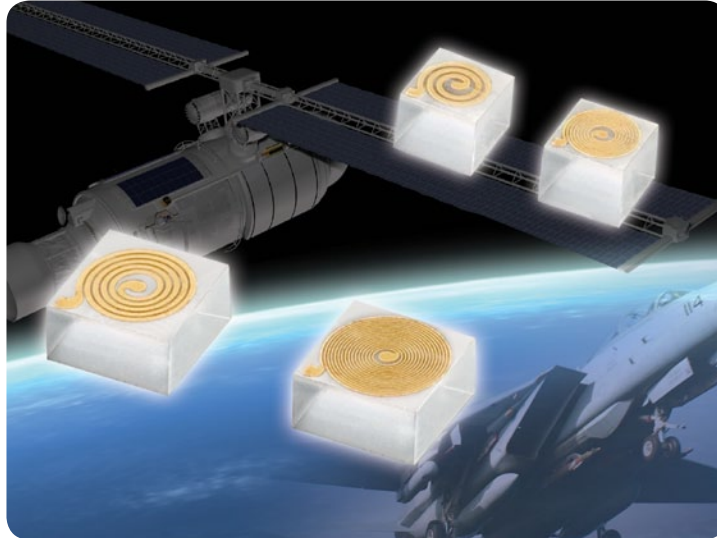


Vishay Electro-Films Wire Bondable RF Spiral Inductor



KEY BENEFITS

- Wire bond assembly
- Small size: 0.030 in. x 0.030 in. x 0.020 in. or 0.050 in. x 0.050 in. x 0.020 in.
- Low DCR, high Q
- Low parasitic capacitance, high SRF
- Equivalent circuit model
- S parameter files available for download
- Available with or without silicon nitride passivation
- Sample kits available

APPLICATIONS

- RF choking for DC biasing
- RF tuning circuits
- Lumped element filters

RESOURCES

- Datasheet: RFLW 3N - <http://www.vishay.com/doc?61057>
- Datasheet: RFLW 5N - <http://www.vishay.com/doc?61087>
- For technical questions contact efi@vishay.com



Vishay Electro-Films Wire Bondable RF Spiral Inductor - RFLW 3N and RFLW 5N


FEATURES

- High frequency
- Wire bond assembly
- Small size: 0.030" x 0.030" x 0.020" (RFLW 3N); 0.050" x 0.050" x 0.020" (RFLW 5N)
- Low DCR, high Q
- Low parasitic capacitance, high SRF
- Equivalent circuit model enclosed
- S parameter files available for download
- Sample kit available
- AEC-Q200 qualified available

APPLICATIONS

- RF choking for DC biasing
- RF tuning circuits
- Lumped element filters

RFLW series of thin film spiral inductors on quartz are designed for RF circuits that require wire bondable components. High precision equivalent circuit modeling enables accurate computer simulation of component performance. Measured S parameter files are also available upon request.

In many RF applications, correct component selection is achieved through experimentation. To help designers during the design process, a sample kit of standard values is available.

Additional values and form factors available upon request.

RFLW 3N

STANDARD ELECTRICAL SPECIFICATIONS								
PARAMETER	VALUE						UNIT	
Inductance Range ⁽¹⁾	0.003 to 0.03						μH	
Tolerance ⁽²⁾	± 20						%	
Max. Power Handling ⁽³⁾	125						mW	
Operating Temperature	- 55 to + 125						°C	
Storage Temperature	- 55 to + 125						°C	
Stability, 1000 h, + 125 °C, 125 mW	2.0 max. ΔR/R						%	
ESD: AEC-Q200-002, component classification 5B (up to 16 kV)	5.0 max. ΔR/R						%	

RF CHARACTERISTICS - TYPICAL VALUES								
PART NUMBER	INDUCTANCE (nH)		DCR (Ω)	IN-CIRCUIT INDUCTANCE ⁽⁴⁾ (nH)	IN-CIRCUIT DCR ⁽⁴⁾ (Ω)	Q (UNITLESS)		SRF (GHz)
	250 MHz	1000 MHz				250 MHz	1000 MHz	
RFLW3N3900C	3.9	3.9	0.3	5	0.4	14	17	> 6
RFLW3N6700C	6.7	6.7	0.6	8	0.7	13	16	> 6
RFLW3N9000C	9	9	1.0	10	1.1	12	15	> 6
RFLW3N1100B	11	11	1.2	12	1.3	11	14	> 6
RFLW3N2000B	20	20	1.6	21	1.7	12	12	> 6
RFLW3N3000B	30	30	2.5	31	2.6	13	13	> 6

RFLW 5N

STANDARD ELECTRICAL SPECIFICATIONS								
PARAMETER	VALUE						UNIT	
Inductance Range ⁽¹⁾	0.018 to 0.150						μH	
Tolerance ⁽²⁾	± 20						%	
Max. Power Handling ⁽³⁾	125						mW	
Operating Temperature	- 55 to + 125						°C	
Storage Temperature	- 55 to + 125						°C	
Stability, 1000 h, + 125 °C, 125 mW	2.0 % max. ΔR/R						%	
ESD: AEC-Q200-002, component classification 5B (up to 16 kV)	5.0 % max. ΔR/R						%	

RF CHARACTERISTICS - TYPICAL VALUES								
PART NUMBER	INDUCTANCE (nH)		DCR (Ω)	IN-CIRCUIT INDUCTANCE ⁽⁴⁾ (nH)	Q (UNITLESS)		SRF (GHz)	
	250 MHz	1000 MHz			250 MHz	1000 MHz		
RFLW5N1800B	18	19	1.0	19	16	13	6	
RFLW5N5200B	47	49	3.3	48	16	9	3.8	
	52	56	3.6	53	17	9	3.5	
RFLW5N8000B	80	87	4.5	82	18	7	2.4	
RFLW5N1000A	100	125	5.4	102	17	5	1.9	
RFLW5N1200A	120	156	7.7	122	18	4	1.7	
RFLW5N1500A	150	220	9.3	152	18	3	1.5	

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⁽¹⁾ Custom values available upon request. See custom design section below.

⁽²⁾ Main source of value tolerance is due to variation in wire bonds. See "test fixture" section below.

⁽³⁾ Maximum rated power of 125 mW at 70 °C, linearly de-rated to zero at 125 °C.

⁽⁴⁾ Including the added inductance and resistance of typical bond wires at 250 MHz. See equivalent circuit section below.